TFT LCD MODULE

2.0 inch 240RGB*320DOTS

MODULE NUMBER: **ZJY200K-IF05**

REVISION: **B**

Customer:

Approved by

From: ZhongjingyuanTechnology Inc.

Approved by

Notes:

1. Please contact Zhongijngyuan Technology Inc. before assigning your product based on this module specification
2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by Limito Technology Inc. for any intellectual property claims or other problems that may result from application based on the module described herein.

Revised History

Part Number	Revision	Revision Content	Revised on
ZJY200K-IF05	A	New	2018-06-26
	B	修改背光 LED 灯的接线原理，增加检验条件和检验标准	2020-7-14

Contents

1. General Description

1.1 Description

ZJY 200K-IF05 is a 240RGBX320 dot-matrix TFT LCD module. This module is composed of a TFT LCD Panel, driver ICs, FPC and a Backlight unit.

1.2 Features

NO.	Item	Contents	Unit
1	LCD Size	2.0	inch
2	Display Mode	Normally black	-
3	Resolution	240(H)RGB x320(V)	pixels
4	Pixel pitch	0.1275(H) x 0.1275(V)	mm
5	Active area	30.6(H) x 40.8(V) mm	mm
6	Module size	34.6(H) x 47.8(V) x2.05(D) mm	mm
7	Pixel arrangement	RGB Vertical stripe	-
8	Interface	8Bit 8080 MCU & 4 Line SPI	-
9	Display Colors	65K	colors
10	Drive IC	ST7789V2	-
11	Luminance(cd/m2)	400 (TYP)	Cd/m2
12	Viewing Direction	All View	Best image
13	Backlight	3 White LED	-
14	Operating Temp.	-20℃~ + 70℃	℃
15	Storage Temp.	-30℃~+ 80℃	℃
16	Weight	7.9	g

2. Mechanical Drawing

NOTES:
1. DISPLAY TYPE: 2.0" TFT
2. VIEWING DIRECTION: A11
3. POLARIZER MODE: TRANSMISSIVE/NORMALLY BLACK
4. DRIVER IC:ST7789V2
5. OPERATING TEMP.: −20°C~70°C
6. STORAGE TEMP.: −30°C~80°C
7. BACK LIGHT: 3 CHIP-WHITE LED
8. LCM Luminance: 400 CD/M2 (TYP)
9. UNMARKED TOLERANCE:±0.2
10. 建议机壳开视窗可视区比 LCD A.A区单边大 0.3mm
11. 产品符合ROHS标准

玻璃靠背光顶部组装

240xRGB×320DOTS
2.0" TFT
ALL VIEWING

IF=20*3mA   VF=2.9V~3.1V
LED CIRCUIT DIAGRAM

接口支持：4SPI/8bit并口

NO.	SYMBOL
1	LED-A
2	LED-K
3	IM2
4	IM1
5	IM0
6	VDD-2.8
7	DB7
8	DB6
9	DB5
10	DB4
11	DB3
12	DB2
13	DB1
14	DB0
15	RD
16	WR
17	RS
18	CS
19	TE
20	RESET
21	SDA
22	GND

LCM

Item	Date	Remark
A	20180626	Original Drawing

Zhongjingyuan technology Inc.

Drawing Number: ZJY200K-IF05
Rev. A
Material: Soda Lime / Polyimide
Scale 1:1   Sheet 1 of 1   Size A3

Unless Otherwise Specified
Unit mm
General Roughness
Dimension ±0.2
Angle ±1

Customer Approval Signature

Title   Drawn   By Letter   Date 20180626
E.E.   Panel/E.   P.M.

3. Pin Definition

FPC Connector is used for the module electronics interface.

NO.	Symbol	Description
1	LEDA	LED Anode
2	LEDK	LED Cathode
3	IM2	The MCU interface mode select
4	IM1	The MCU interface mode select
5	IM0	The MCU interface mode select
6	VDD-2.8	Power Supply for Analog,VDD-2.8=2.5V-3.3V
7~14	DB7~DB0	MCU parallel interface data
15	RD	Read MCU parallel interface
16	WR	Write enable in MCU parallel interface .Display data/command selection pin in 4-line serial interface.
17	RS	Display data/command selection pin
18	CS	Chip selection pin ; Low enable ,high disable.
19	TE	Tearing effect signal is used to synchronize MCU to frame memory.
20	RESET	This signal will reset the device and it must be applied to properly initialize the chip .Signal is active low.
21	SDA	SPI interface input/output pin .the data is latched on the rising edge of the SCL signal.
22	GND	Power Ground

Note:

IM2=IM1=IM0=GND，interface mode select 80-8bit parallel I/F.

IM2=IM1=VDD,IM0=GND, interface mode select 4-line 8bit serial I/F.

VCC=3.3V

并口参考电路   SPI接口参考电路

背光控制参考电路
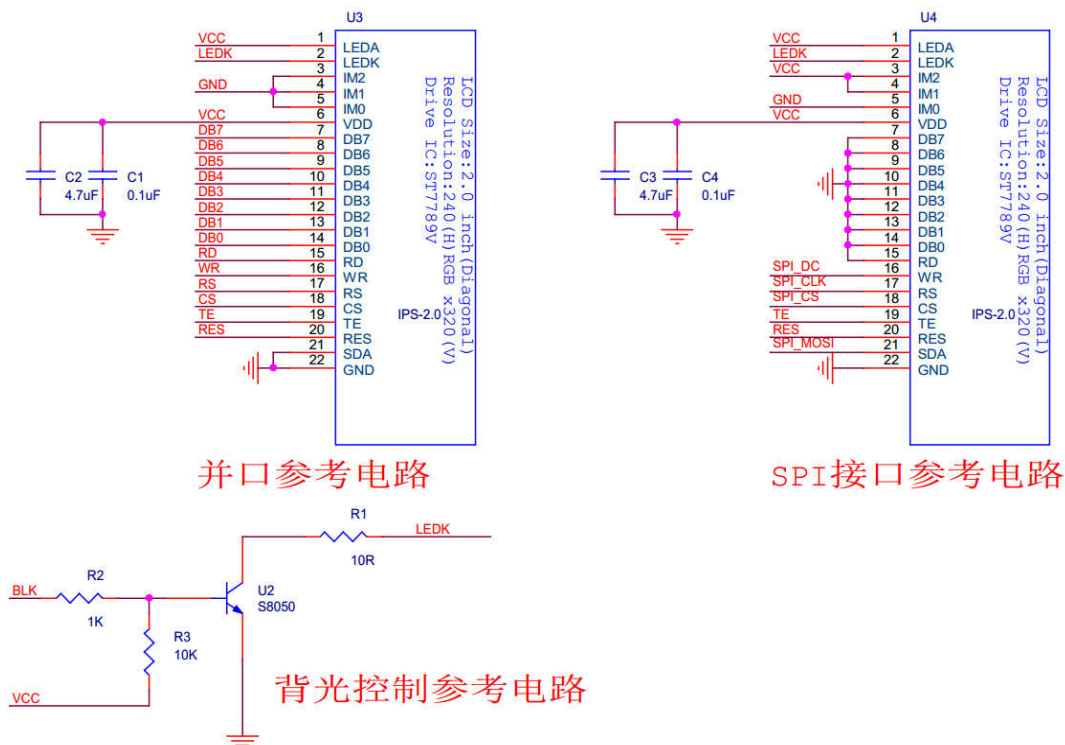
4. Electrical Characteristics

4.1 Absolute Maximum Ratings

Parameter	Symbol	Min	MAX	Unit	Notes
Supply Voltage (I/O)	VDD	-0.3	4.6	V	
Analog Supply Voltage	VDDIO	-0.3	4.6	V	
Logic Input Voltage	VIN	-0.3	VDDIO+0.5	V	
Operation Temperature	Top	-20	70	℃	
Storage Temperature	Tst	-30	80	℃	

4.2 Operating Conditions

Parameter	Symbol	Min	TYP	MAX	Unit	Notes
System Voltage	VDD	2.5	2.8	3.3	V	
Gate Driver High Voltage	VGH	12.2	-	14.97	V	
Gate Driver Low Voltage	VGL	-12.5	-	-7.16	V	
Operating Current for V_{DD}	I_{DD}	-	8	10	mA	
Sleep_In Mode VDD	I_{dd}	-	15	30	uA	
Sleep_In Mode VDDIO	I_{ddio}	-	5	10	uA	

4.3 Backlight Unit

Parameter	Symbol	Min	TYP	MAX	Unit	Notes
Voltage for LED backlight	VLED	2.9	3.0	3.1	V	
Current for LED backlight	ILED	-	60	90	mA	3 LED
Power Consumption	Pbl	-	180	288	mW	1
Brightness	L_{br}	350	400	-	cd/m^2	2
LED Life time	-	20000	-	-	hr	3

Note:
1. Where ILED =60mA , VLED=3.0V , Pbl= ILED x VLED
2. Uniform measure condition:
   a:Measure 9 point ,Measure location is show below:
   b:Uniform=(Min brightness/Max brightness)x100%
   c:Best Contrast.
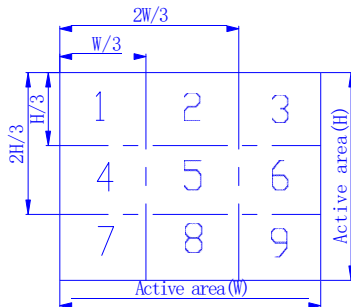
3. The environmental conducted under ambient air flow ,at Ta=25±2°C,60%RH±5%

4.4 Backlight Recommended Circuit

Motherboard driver backlight is need constant current circuit , if threated voltage screen after light brightness difference . Current and power consumption of the machine are inconsistent , so recommend a backlight driving circuit is best rated current . It is recommended to use IC (AW9364) . The reference circuit is as follows:
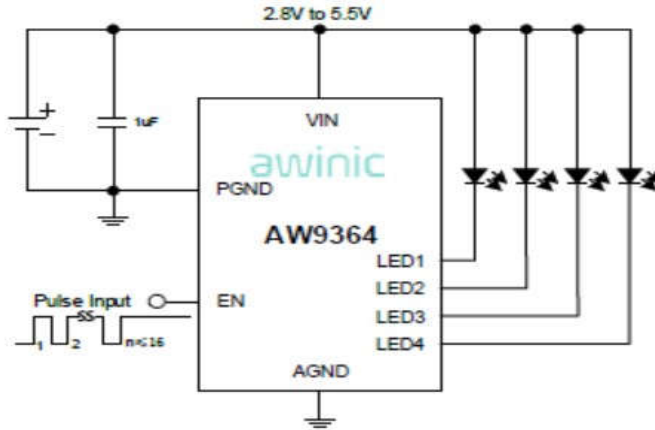

4.5 AC Timing Characteristic of The LCD

8080 Series MCU Parallel interface Characteristics:
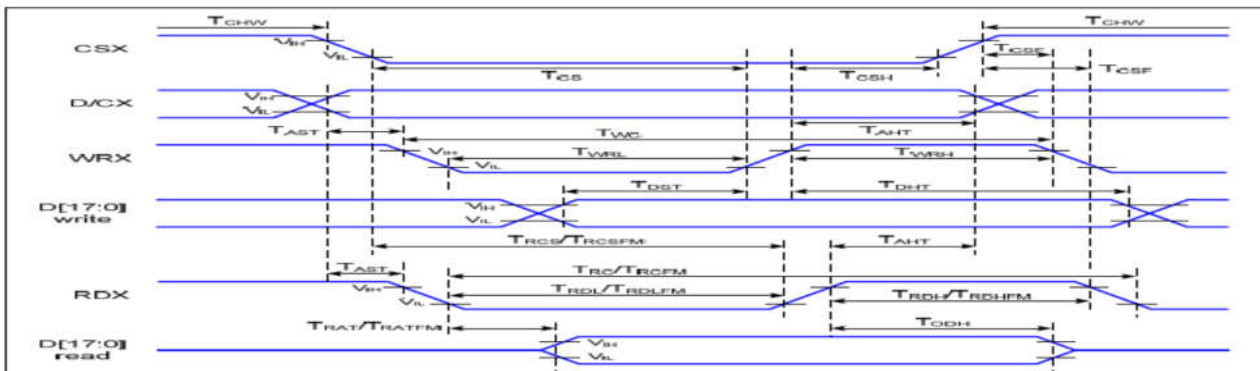
Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	-
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	-
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	
	T_{WRH}	Control pulse "H" duration	15		ns	
	T_{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF

Serial interface Characteristics(4-line serial):
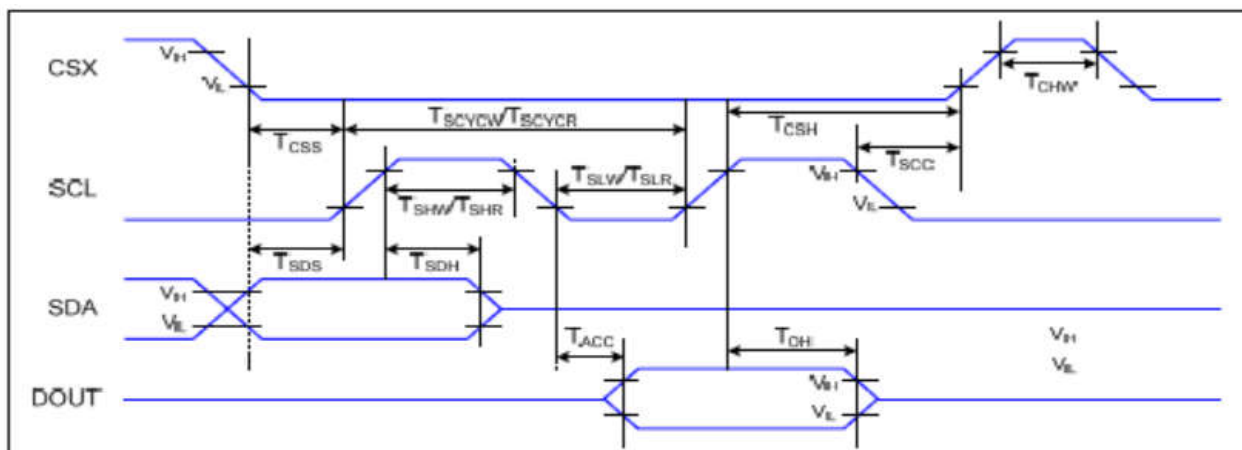
Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	16		ns	
	T_{SHW}	SCL "H" pulse width (Write)	7		ns	
	T_{SLW}	SCL "L" pulse width (Write)	7		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T_{SDS}	Data setup time	7		ns	
	T_{SDH}	Data hold time	7		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

5. OPTICAL CHARACTERISTICS

Item	Symbol	Measuring Conditions		Min.	Typ.	Max.	Unit	Remark
Viewing Angle	θ	$\phi = 0^o$	25 °C	-	80	-	Deg	Note1
		$\phi = 180^o$	25 °C	-	80	-		
	θ	$\phi = 90^o$	25 °C	-	80	-		
		$\phi = 270^o$	25 °C	-	80	-		
Brightness	L_{br}	--	-	350	400	-	Cd/m2	
Luminance Uniformity	ΔL	--	-	70	75	-		
Contrast Ratio	CR	--	25 °C	640	800	-	--	Note2
Response Time	Tr+Tf	$\theta = 0^o$ $\phi = 0^o$	25 °C	-	30	40	ms	Note3
Color of CIE Coordinate	White	X	25 °C	-0.03	0.296	+0.03	--	BM-7A
		Y	25 °C		0.325			
	Red	X	25 °C		0.647			
		Y	25 °C		0.329			
	Green	X	25 °C		0.279			
		Y	25 °C		0.550			
	Blue	X	25 °C		0.134			
		Y	25 °C		0.123			
Transmittance (with polarizer)	--	--	--	-	4.5	-	%	--

Note 1 Definition of Viewing Angle:
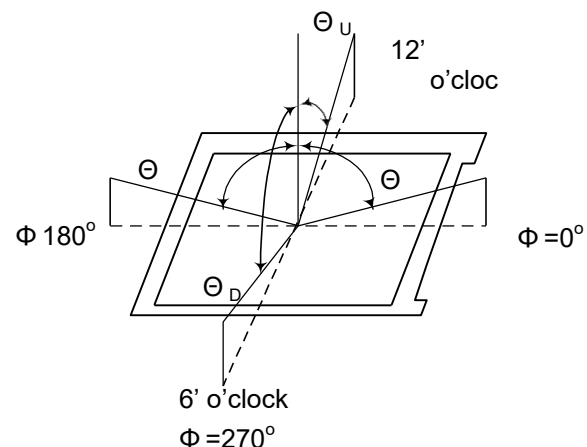
Note 2:Definition of Contrast Ratio (CR) :
measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$
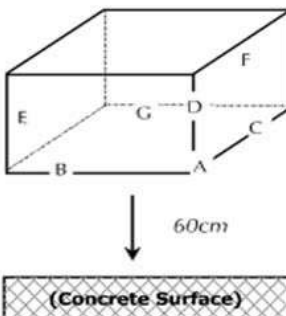
Note 3: Definition of Response Time : Sum of Tr and Tf :
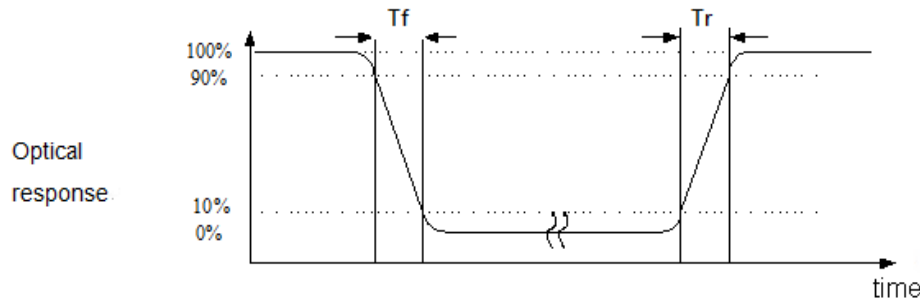
6. Reliability

Contents of Reliability Tests

No.	Item	Conditions	Note
1	High Temperature Operation	70°C±2°C, 120 hrs	
2	Low Temperature Operation	-20°C±2°C, 120 hrs	
3	High Temperature Storage	80°C±2°C, 120 hrs	
4	Low Temperature Storage	-30°C±2°C, 120 hrs	
5	High Temperature /Humidity Operation	60°C±2°C, 90% RH, 120 hrs	
6	Temperature Cycling	-10°C→25°C→60°C→25°C→-10°C 30min 5min 30min 5min 30min 10 cycle.	
7	Vibration Test	Total fixed amplitude:1.5mm. Vibration Frequerncy:10~55Hz One cycle 60 seconds to 3 direction of X,Y,Z each 15 minutes.	
8	ESD Test	Air Discharge:Apple ±4KV with 5 times.	
		Contact Discharge:Apple ±2KV with 5 times.	
9	Drop Test	To be measured after dropping from 60cm high on the concrete surface in packing state. 	

Note:
　　No charge on display and in operation under the following test condition.
　　Please note that the reliability test project requires the use of virgin samples
　　Condition : Unless otherwise specified ,tests will be conducted under the following condition.
　　　　Temperature:20°C±5°C.
　　　　Humidity:65±5%RH.
　　　　Tests will be not conducted under functioning state.

7. Package Specifications

Item		Quantity	
Module		300	per Primary Box
Holding Trays	(A)	15	per Primary Box
Total Trays	(B)	16	per Primary Box (Including 1 Empty Tray)
Primary Box	(C)	1~4	per Carton (4 as Major / Maximum)
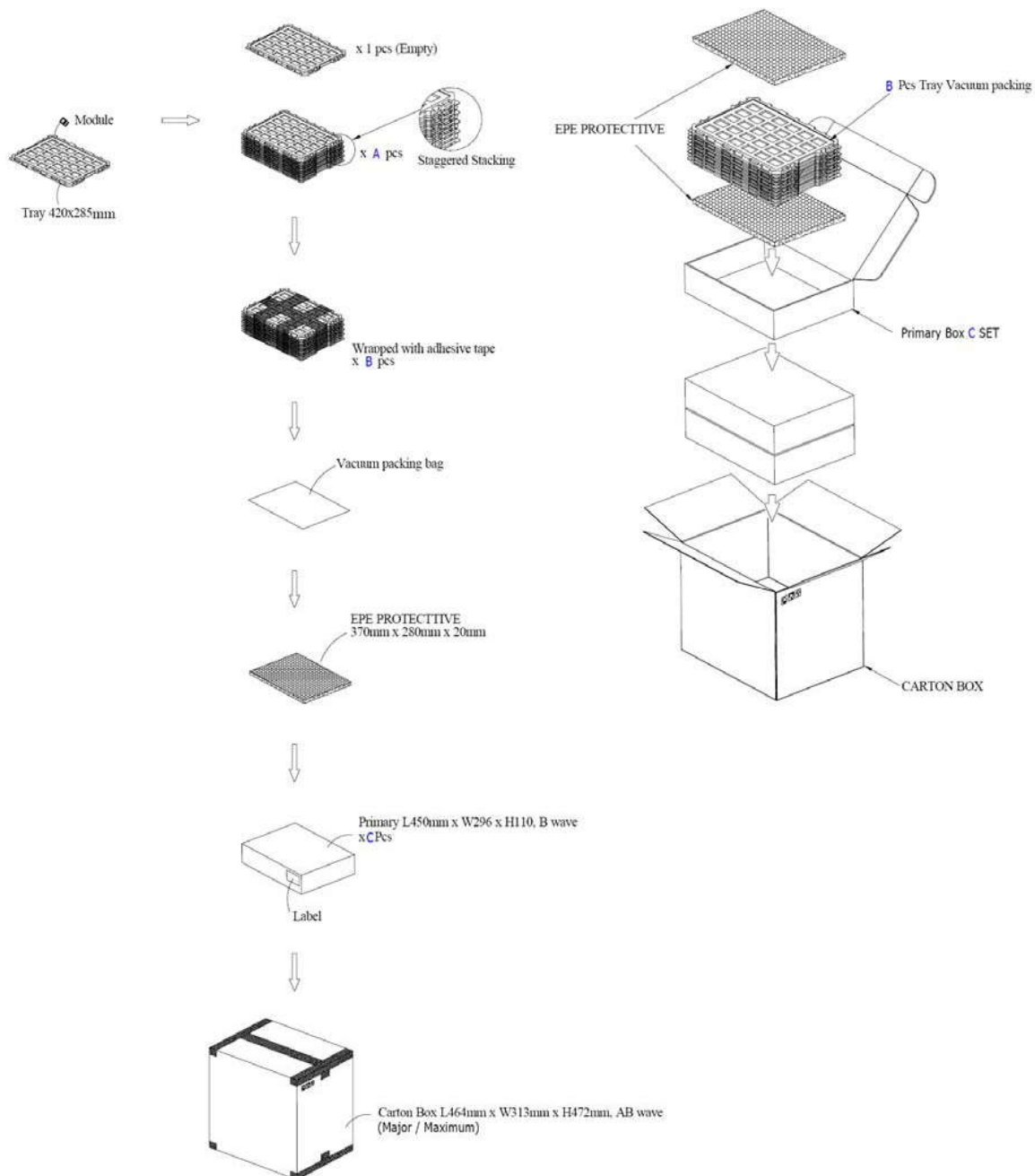
8. Incoming Inspection Standards

8.1. Inspection and Environment Conditions

8.1.1. Inspection Conditions:

(1) Inspection Distance :35 cm±5cm

(2) View Angle : Light-on Inspection Angle:±5°

　　　　Cosmetic Inspection Angle:±45°
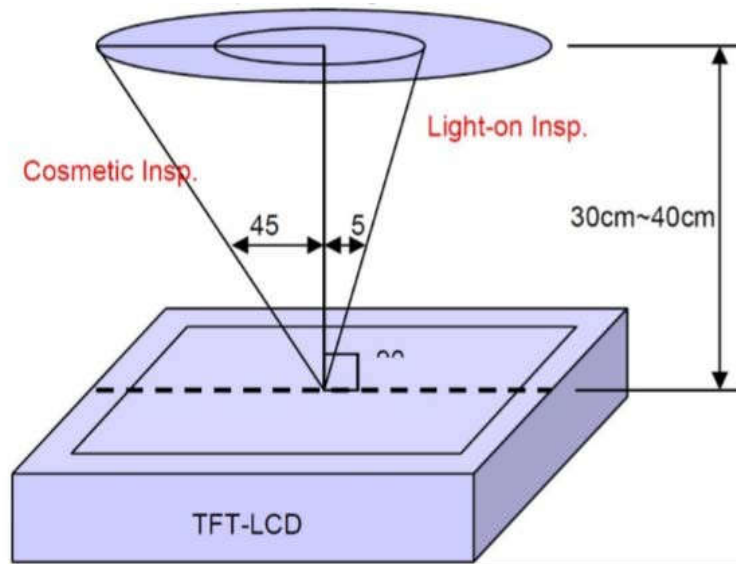
(perpendicular to LCD panel surface)

8.1.2 Environment Conditions:

Ambient Temperature		23℃±5℃
Ambient Humidity		55±10％RH
Ambient Illumination	Cosmetic Inspection	More than 600 Lux
	Functional Inspection	300~500 Lux

8.1.3 Sampling Conditions:
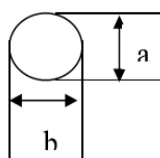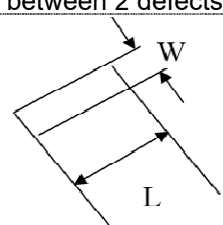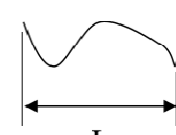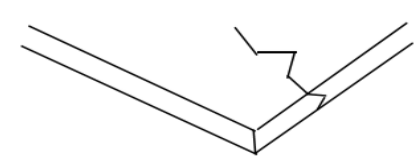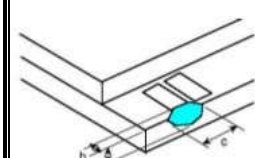
（1）　Lot Size:Quantity of shipment lot per model

（2）　Sampling Method:

Sampling Plan		MIL-STD-105E
		Normal Inspection，Single Sampling
		Level Ⅱ
AQL	Major Defect	0.65%
	Minor Defect	1.5%
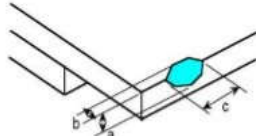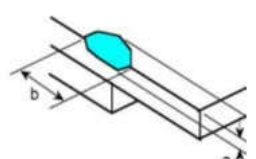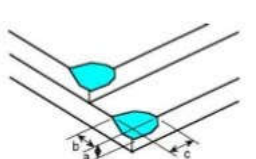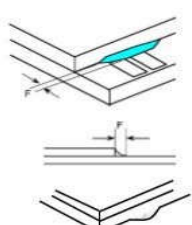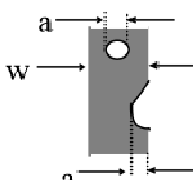
8.1.4 Inspection Criteria

8.1.4.1 Cosmetic Inspection(Panel):

Check Item	Classification	Criteria(Unit: mm)
Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell.	Minor	$\varphi = (a + b)/2$ 	Area / Size	Acc. Qty
$\varphi \leq 0.10$	Ignore
$0.10 < \varphi \leq 0.15$	2
$0.15 < \varphi \leq 0.20$	1
$0.20 < \varphi$	0
Total	2 no include $\varphi \leq 0.10$	 Distance between 2 defects should more than 5mm apart.
Black and White line Scratch Foreign material (Line type)	Minor		Length	Width	Acc. Qty
/	$W \leqq 0.03$	Ignore
$L \leqq 2$	$0.03 < W \leqq 0.05$	1
/	$0.05 < W$	0
	Total	1 | Distance between 2 defects should more than 5mm apart. Scratches not viewable through the back of the display are acceptable.
Glass Crack	Minor	 LCD with extensible crack line is unacceptable(When press the cracked LCD Area, the line will expand,we define it is extensible crack line)
Glass Chipping Pad Area	Minor		Length and Width	Acc. Qty
$c < 5.0$, $b < 0.4$	Ignore	

Check Item	Classification	Criteria(Unit: mm)
Glass Chipping Rear Of Pad Area	Minor	Length and Width / Acc. Qty $c > 3.0, b < 1.0$ → 1 $c < 3.0, b < 1.0$ → 2 $c < 3.0, b < 0.5$ → 4 a<Glass Thickness
Glass Chipping Except Pad Area	Minor	Length and Width / Acc. Qty $c \leq 0.6, b < 5.0$ → Ignore a<Glass Thickness
Glass Corner Chipping	Minor	Length and Width / Acc. Qty $c < 2.0, b < 1.5$ → Ignore $c < 1.5, b < 2$ → Ignore a<Glass Thickness
Glass Burr	Minor	Glass burr don't affect assemble and module dimension. Length / Acc. Qty $F < 0.5$ → Ignore
FPC Defect	Minor	1.Dent , pinhole width $a < W/2$. (W:circuitry width) 2.Open circuit is unacceptable. 3.No oxidation, contamination and distortion.
Bubble on Polarizer	Minor	Diameter / Acc. Qty $\varphi \leq 0.15$ → Ignore $0.15 < \varphi \leq 0.20$ → 2 $0.20 < \varphi \leq 0.30$ → 1 $0.3 < \varphi$ → None

Check Item	Classification	Criteria(Unit: mm)		
Dent on Polarizer	Minor	**Diameter**		**Acc. Qty**
		$\varphi \leq 0.15$		Ignore
		$0.15 < \varphi \leq 0.20$		2
		$0.20 < \varphi \leq 0.30$		1
		$0.3 < \varphi$		None
Screen deformation	/	Test for insertion of plug gauge at highest warping point: $H \leq 0.25mm$ The client has special requirements, according to drawing.		
Bezel	/	1.No rust, distortion on the Bezel. 2.No visible fingerprints, stains or other contamination.		

Touch Panel	/	D:Diameter W: width L: length
		 1.Spot: $D \leq 0.2$ is acceptable
		     $0.2 < D \leq 0.3$, acceptable Inspection and Environment Conditions
		     2dots are acceptable and the distance between defects
		     Should more than 5mm.
		     $D > 0.3$ is unacceptable
		 2.Dent: $D > 0.3$ is unacceptable.
		 3.Scratch: $W \leq 0.03, L \leq 10$ is acceptable,
		     $0.03 < W \leq 0.1$, $L \leq 10$, acceptable Inspection and Environment Conditions
		 Distance between 2 defects should more than 5 mm.
		     $W > 0.1$ is unacceptable.		

PCB	/	1.No distortion or contamination on PCB terminals. 2.All components on PCB must same as documented on the BOM/component layout. 3.Follow IPC-A-600F.		
Soldering	/	Follow IPC-A-610C standard.		
Leak	/	Yellow light, OK。White light, According to the limit sample		

Check Item	Classification	Criteria(Unit: mm)
Electrical Defect	Major	The below defects must be rejected. 1. Missing vertical / horizontal segment. 2. Abnormal Display. 3. No function or no display. 4. Current exceeds product specifications. 5. LCD viewing angle defect. 6. No Backlight. 7. Dark Backlight. 8. Touch Panel no function. 9. Dark Dot –one Allowed. 10. Bright Dot- one Allowed.

9. Precautions When Using These TFT Display Modules

9.1 Handling Precautions

1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
3) If pressure is applied to the display surface or its neighborhood of the TFT display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
4) The polarizer covering the surface of the TFT display module is soft and easily scratched. Please be careful when handling the TFT display module.
5) When the surface of the polarizer of the TFT display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
   * Scotch Mending Tape No. 810 or an equivalent
   Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
   Also, pay attention that the following liquid and solvent may spoil the polarizer:
   * Water
   * Ketone
   * Aromatic Solvents
6) Hold TFT display module very carefully when placing TFT display module into the system housing. Do not apply excessive stress or pressure to TFT display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.
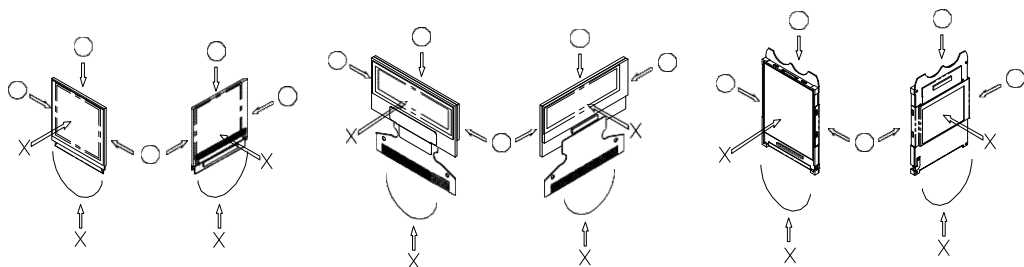
7) Do not apply stress to the driver IC and the surrounding molded sections.
8) Do not disassemble nor modify the TFT display module.
9) Do not apply input signals while the logic power is off.

10) Pay sufficient attention to the working environments when handing TFT display modules to prevent occurrence of element breakage accidents by static electricity.
* Be sure to make human body grounding when handling TFT display modules.
* Be sure to ground tools to use or assembly such as soldering irons.
* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
* Protective film is being applied to the surface of the display panel of the TFT display module. Be careful since static electricity may be generated when exfoliating the protective film.

11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the TFT display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).

12) If electric current is applied when the TFT display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

9.2 Storage Precautions

1) When storing TFT display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than $0°C$) environments. (We recommend you to store these modules in the packaged state when they were shipped from Limito technology Inc.)
At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

2) If electric current is applied when water drops are adhering to the surface of the TFT display module, when the TFT display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

9.3 Designing Precautions

1) The absolute maximum ratings are the ratings which cannot be exceeded for TFT display module, and if these values are exceeded, panel damage may be happen.

2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible.

3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}). (Recommend value: 0.5A)

4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

5) As for EMI, take necessary measures on the equipment side basically.

6) When fastening the TFT display module, fasten the external plastic housing section.

7) If power supply to the TFT display module is forcibly shut down by such errors as taking out the main battery while the TFT display panel is in operation, we cannot guarantee the quality of this OEL display module.

8) The electric potential to be connected to the rear face of the IC chip should be as follows:
* Connection (contact) to any other potential than the above may lead to rupture of the IC.

9.4 Precautions when disposing of the TFT display modules

1) Request the qualified companies to handle industrial wastes when disposing of the TFT display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

9.5 Other Precautions

1) When an TFT display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored.   Also, there will be no problem in the reliability of the module.

2) To protect TFT display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the TFT display modules.
* Pins and electrodes
* Pattern layouts such as the FPC

3) With this TFT display module, the TFT driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this TFT driver is exposed to light, malfunctioning may occur.
   * Design the product and installation method so that the TFT driver may be shielded from light in actual usage.
   * Design the product and installation method so that the TFT driver may be shielded from light during the inspection processes.
4) Although this TFT display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

10. *Warranty:*

The warranty period shall last twelve (12) months from the date of delivery. Buyer shall be completed to assemble all the processes within the effective twelve (12) months. Limito technology Inc. shall be liable for replacing any products which contain defective material or process which do not conform to the product specification, applicable drawings and specifications during the warranty period. All products must be preserved, handled and appearance to permit efficient handling during warranty period. The warranty coverage would be exclusive while the returned goods are out of the terms above.

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